

P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY									
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)						
- 12	0.029 at V _{GS} = - 4.5 V	- 12 ^a							
	0.034 at V _{GS} = - 2.5 V	- 12 ^a	23 nC						
	0.044 at V _{GS} = - 1.8 V	- 12 ^a	23110						
	0.100 at V _{GS} = - 1.5 V	- 3							

FEATURES

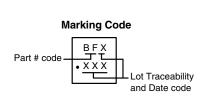
- TrenchFET® Power MOSFET
- New Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

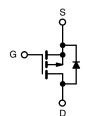


HALOGEN FREE

APPLICATIONS

Load Switch, PA Switch and Battery Switch for Portable Devices





P-Channel MOSFET

PowerPAK SC-70-6L-Single
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Ordering Information:

SiA413DJ-T4-GE3 (Lead (Pb)-free and Halogen-free) SiA413DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 12	V	
Gate-Source Voltage		V _{GS}	± 8		
Continuous Drain Current (T _J = 150 °C)	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$	I _D	- 12 ^a - 12 ^a - 10 ^{b, c} - 8 ^{b, c}	A	
Pulsed Drain Current	·	I _{DM}	- 40		
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$	I _S	- 12 ^a - 2.9 ^{b, c}		
Maximum Power Dissipation	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	P _D	19 12 3.5 ^{b, c} 2.2 ^{b, c}	w	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	oc.		
Soldering Recommendations (Peak Temperatur	e) ^{d, e}		260		

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5	O/ VV				

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.

Document Number: 70447 S12-1141-Rev. D, 21-May-12

For more information please contact: pmostechsupport@vishay.com

SiA413DJ

Vishay Siliconix



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)									
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static									
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = - 250 μA	- 12			V			
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 11		mV/°C			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	η = - 200 μπ		2.7					
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	- 0.4		- 1	V			
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA			
Zero Gate Voltage Drain Current	lass	$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	1.1			
Zelo Gate Voltage Diain Current	IDSS	V_{DS} = - 12 V, V_{GS} = 0 V, T_{J} = 55 °C		- 10	μΑ				
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α			
		$V_{GS} = -4.5 \text{ V}, I_D = -6.7 \text{ A}$		0.024	0.029				
	Б	$V_{GS} = -2.5 \text{ V}, I_D = -6.2 \text{ A}$		0.028	0.034				
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -1.8 \text{ V}, I_D = -2.3 \text{ A}$		0.036	0.044	Ω			
		V _{GS} = - 1.5 V, I _D = - 1 A		0.050	0.100				
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 6.7 A		30		S			
Dynamic ^b									
Input Capacitance	C _{iss}			1800		pF			
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		450					
Reverse Transfer Capacitance	C _{rss}			390					
Total Cata Chausa	0	$V_{DS} = -6 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -10 \text{ A}$		38	57	nC			
Total Gate Charge	Q_g			23	35				
Gate-Source Charge	Q _{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$		3					
Gate-Drain Charge	Q_{gd}			6.5					
Gate Resistance	R_g	f = 1 MHz		7		Ω			
Turn-On Delay Time	t _{d(on)}	n)		20	30				
Rise Time	t _r	V_{DD} = - 6 V, R_L = 0.75 Ω		40	60	ns			
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 8 A, $V_{GEN}=$ - 4.5 V, $R_g=$ 1 Ω		65	100				
Fall Time	t _f			40	60				
Turn-On Delay Time	t _{d(on)}			10	15				
Rise Time	t _r	V_{DD} = - 6 V, R_L = 0.75 Ω		12	20				
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 8 A, V_{GEN} = - 8 V, R_g = 1 Ω		70	105				
Fall Time	t _f			40	60				
Drain-Source Body Diode Characteristic	cs								
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 12	Α			
Pulse Diode Forward Current	I_{SM}				40	^			
Body Diode Voltage	V_{SD}	I _S = -8 A, V _{GS} = 0 V		- 0.8	- 1.2	V			
Body Diode Reverse Recovery Time	t _{rr}			40	60	ns			
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 8 A, di/dt = 100 A/μs, T _{.I} = 25 °C		20	30	nC			
Reverse Recovery Fall Time	t _a	1 _F = 0 Λ, α/αι = 100 Λ/μο, 1 _J = 25 0		14		ne			
Reverse Recovery Rise Time	t _b			26		ns			

Notes:

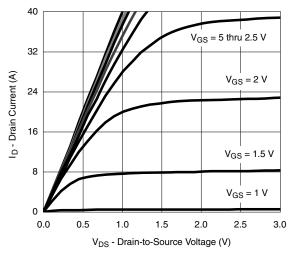
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

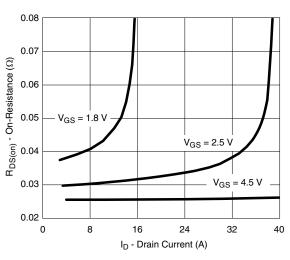
b. Guaranteed by design, not subject to production testing.



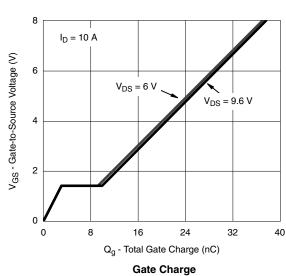
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

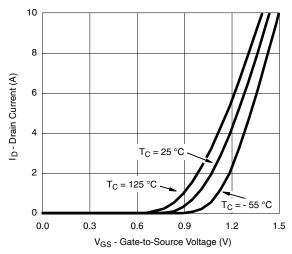


Output Characteristics

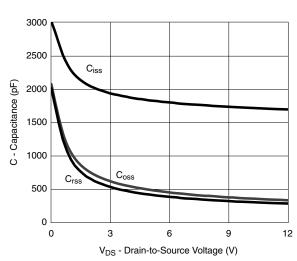


On-Resistance vs. Drain Current and Gate Voltage

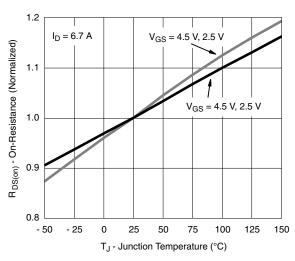




Transfer Characteristics

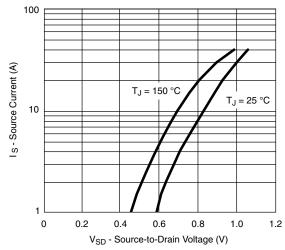


Capacitance

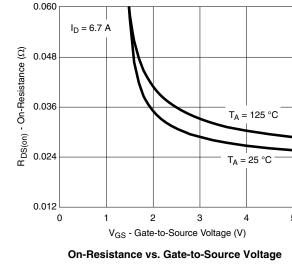


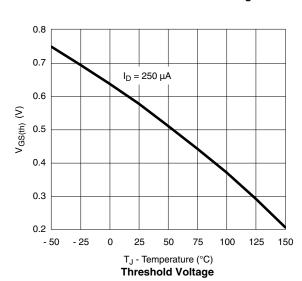
On-Resistance vs. Junction Temperature

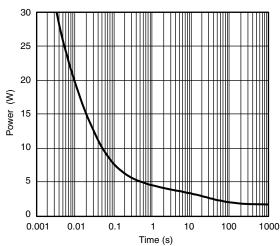
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



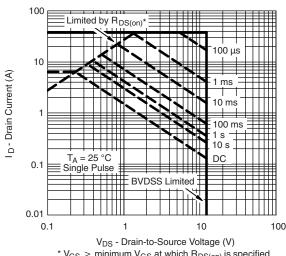
Soure-Drain Diode Forward Voltage







Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

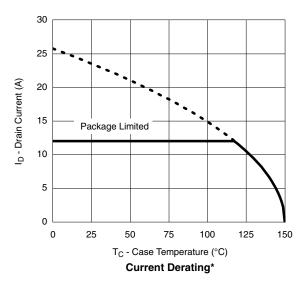
Safe Operating Area, Junction-to-Ambient

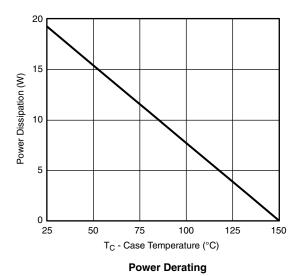






TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

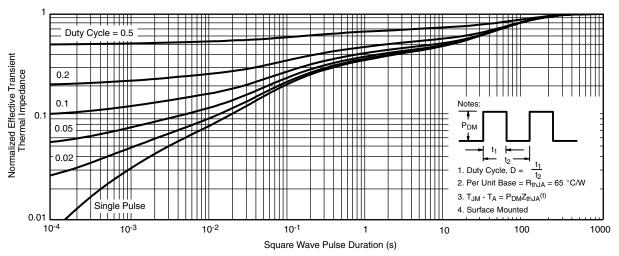




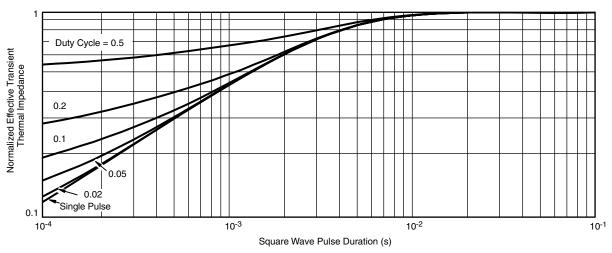
 $^{^{\}star}$ The power dissipation P_D is based on T_{J(max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



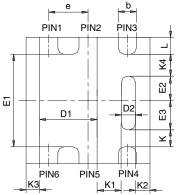
Normalized Thermal Transient Impedance, Junction-to-Case

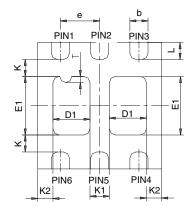
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?70447





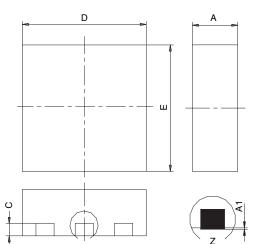
PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

	SINGLE PAD						DUAL PAD					
DIM	M	ILLIMETER	RS		INCHES MILLIMETERS		RS	INCHES				
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
Е	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC		
K		0.275 TYP			0.011 TYP		0.275 TYP		0.011 TYP			
K1		0.400 TYP			0.016 TYP		0.320 TYP			0.013 TYP		
K2		0.240 TYP		0.009 TYP		0.252 TYP		0.010 TYP				
К3		0.225 TYP		0.009 TYP				•		•	•	
K4		0.355 TYP		0.014 TYP		_						
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006

DETAIL Z

ECN: C-07431 - Rev. C, 06-Aug-07

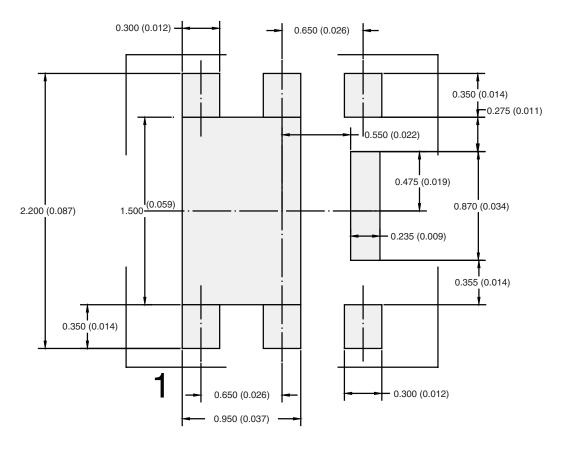
DWG: 5934

Document Number: 73001

06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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